## <mark>查询"EDD8N50NZ"供应商</mark> FAIRCHILD

SEMICONDUCTOR®

# FDD8N50NZ N-Channel MOSFET 500V, 6.5A, 0.85Ω

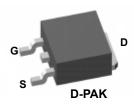
## Features

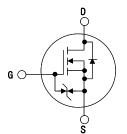
- +  $R_{DS(on)} = 0.77\Omega$  (Typ.) @  $V_{GS} = 10V$ ,  $I_D = 3.25A$
- Low Gate Charge (Typ. 14nC)
- Low C<sub>rss</sub> ( Typ. 5pF)
- Fast Switching
- 100% Avalanche Tested
- Improve dv/dt Capability
- ESD Improved Capability
- RoHS Compliant

# Description

This N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advance technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficient switching mode power supplies and active power factor correction.





## MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units
V <sub>DSS</sub>	Drain to Source Voltage			500	V
V <sub>GSS</sub>	Gate to Source Voltage			±25	V
ID	Drain Current	-Continuous ( $T_C = 25^{\circ}C$ )		6.5	
		-Continuous ( $T_C = 100^{\circ}C$ )		3.9	— A
I <sub>DM</sub>	Drain Current	- Pulsed (Note 1)		26	A
E <sub>AS</sub>	Single Pulsed Avalanche Energy		(Note 2)	287	mJ
I <sub>AR</sub>	Avalanche Current		(Note 1)	6.5	A
E <sub>AR</sub>	Repetitive Avalanche Energy		(Note 1)	9	mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	10	V/ns
P <sub>D</sub>	Power Dissipation	$(T_{C} = 25^{\circ}C)$		90	W
		- Derate above 25°C		0.7	W/ºC
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C
Τ <sub>L</sub>	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C

\*Drain current limited by maximum junction temperature

## **Thermal Characteristics**

Symbol	Parameter	Ratings	Units
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.4	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	62.5	C/VV

)		Packag	е	Reel Size	Таре	e Width		Quantit	y	
		D-PA	AK 380mm		16mm		2500			
Electrica	l Char	acteristics ⊤ <sub>c</sub> =	25°C unless of	otherwise not	ed					
Symbol	Parameter		Test Conditions		Min.	Тур.	Max.	Unit		
Off Charac	teristic	S								
BV <sub>DSS</sub>	Drain to	o Source Breakdown V	oltage	$I_{D} = 250 \mu A, V_{GS} = 0V, T_{C} = 25^{\circ}C$			500	-	-	V
ΔBV <sub>DSS</sub> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient		ure	$I_D = 250 \mu A$ , Referenced to $25^{\circ}C$		-	0.5	-	V/ºC	
1	Zoro C				$V_{DS} = 500V, V_{GS} = 0V$		-	-	1	
DSS	Zero Gate Voltage Drain Current			$V_{DS} = 400V, T_{C} = 125^{\circ}C$			-	-	10	μΑ
I <sub>GSS</sub>	Gate to Body Leakage Current			$V_{GS} = \pm 25V$	$V_{DS} = 0V$		-	-	±10	μA
On Charac	teristic	S								
V <sub>GS(th)</sub>	Gate Threshold Voltage			V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250μA		3.0	-	5.0	V	
R <sub>DS(on)</sub>	Static D	Static Drain to Source On Resistance			V <sub>GS</sub> = 10V, I <sub>D</sub> = 3.25A			0.77	0.85	Ω
9 <sub>FS</sub>	Forward Transconductance			V <sub>DS</sub> = 20V, I	<sub>D</sub> = 3.25A	(Note 4)	-	6.3	-	S
C <sub>iss</sub> C <sub>oss</sub>	Output	nput Capacitance Dutput Capacitance		V <sub>DS</sub> = 25V, f = 1MHz	V <sub>GS</sub> = 0V	-	-	565 80	735 105	pF pF
C <sub>rss</sub>		e Transfer Capacitance	;			-	5	8	pF	
Q <sub>g(tot)</sub>		Total Gate Charge at 10V Gate to Source Gate Charge		V <sub>DS</sub> = 400V,I <sub>D</sub> = 6.5A ∀V <sub>GS</sub> = 10V		-	14	18	nC	
Q <sub>gs</sub>						-	4	-	nC	
Q <sub>gd</sub>		Drain "Miller" Charge		(Note 4, 5)		-	6	-	nC	
Switching	-			1		1			1	-1
t <sub>d(on)</sub>		Turn-On Delay Time				-	-	17	45	ns
t <sub>r</sub>		n Rise Time		$V_{DD} = 250V, I_D = 6.5A$ $R_G = 25\Omega, V_{GS} = 10V$		-	34	80	ns	
t <sub>d(off)</sub>		f Delay Time				-	43	95	ns	
t <sub>f</sub>		f Fall Time				(Note 4, 5)	-	27	60	ns
		de Characteristic					I			
ls	Maximum Continuous Drain to Source Diod					-	-	8	Α	
I <sub>SM</sub>		m Pulsed Drain to Sou				-	-	30	A	
V <sub>SD</sub>	Drain to	Source Diode Forward	d Voltage	$V_{GS} = 0V, I_{SD} = 6.5A$		-	-	1.4	V	
-	-				$V_{GS} = 0V, I_{SD} = 6.5A$					
t <sub>rr</sub>		e Recovery Time e Recovery Charge		$V_{GS} = 0V, I_{S}$ $dI_{E}/dt = 100$		(Note 4)	-	228	-	ns μC

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. L = 13.6mH, I\_{AS} = 6.5A, V\_{DD} = 50V, R\_G = 25 $\Omega$ , Starting T\_J = 25°C

3.  $I_{SD} \leq 6.5 A, \, di/dt \leq 200 A/\mu s, \, V_{DD} \leq B V_{DSS}, \, Starting \, T_J$  =  $25^{\circ}C$ 

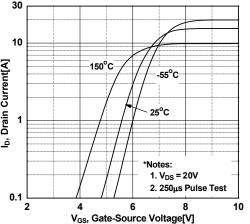
4. Pulse Test: Pulse width  $\leq 300 \mu \text{s}, \, \text{Duty Cycle} \leq 2\%$ 

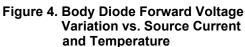
5. Essentially Independent of Operating Temperature Typical Characteristics

FDD8N50NZ N-Channel MOSFET

#### 查询"FDD8N50NZ"供应商 **Typical Performance Characteristics Figure 1. On-Region Characteristics** 30 30 V<sub>GS</sub> = 15.0 V 10.0 V 10 8.0 V 10 7.0 V 6.5 V I<sub>D</sub>, Drain Current[A] I<sub>b</sub>, Drain Current[A] 6.0 V 5.5 V 1 1 0.1 \*Notes: 1. 250µs Pulse Test 2. T<sub>C</sub> = 25<sup>o</sup>C 0.03 LZ 0.03 1 10 20 0.1 V<sub>DS</sub>, Drain-Source Voltage[V] Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage 2.0 Drain-Source On-Resistance 80 7.1 8.1 9.1 l<sub>s</sub>, Reverse Drain Current [A] $R_{DS(ON)}$ [ $\Omega$ ], V<sub>GS</sub> = 10V V<sub>GS</sub> = 20V \*Note: T<sub>c</sub> = 25°C 0.4 3 15 0 6 9 12 18 ID, Drain Current [A] **Figure 5. Capacitance Characteristics** 1200 $C_{iss} = C_{gs} + C_{gd}$ ( $C_{ds} =$ shorted) Coss = Cds + Cgd Coss Gate-Source Voltage [V] C<sub>rss</sub> = C<sub>gd</sub> 900 \*Note: Capacitances [pF] 1. V<sub>GS</sub> = 0V Ciss 2. f = 1MHz 600 4 V<sub>GS</sub>, 300 C<sub>rss</sub>

Figure 2. Transfer Characteristics





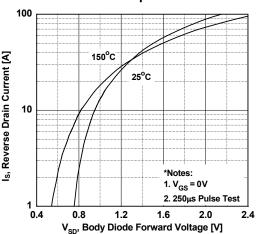
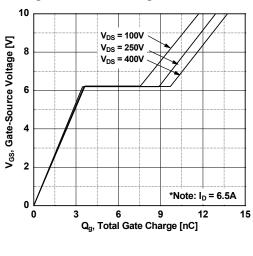


Figure 6. Gate Charge Characteristics



FDD8N50NZ Rev. A

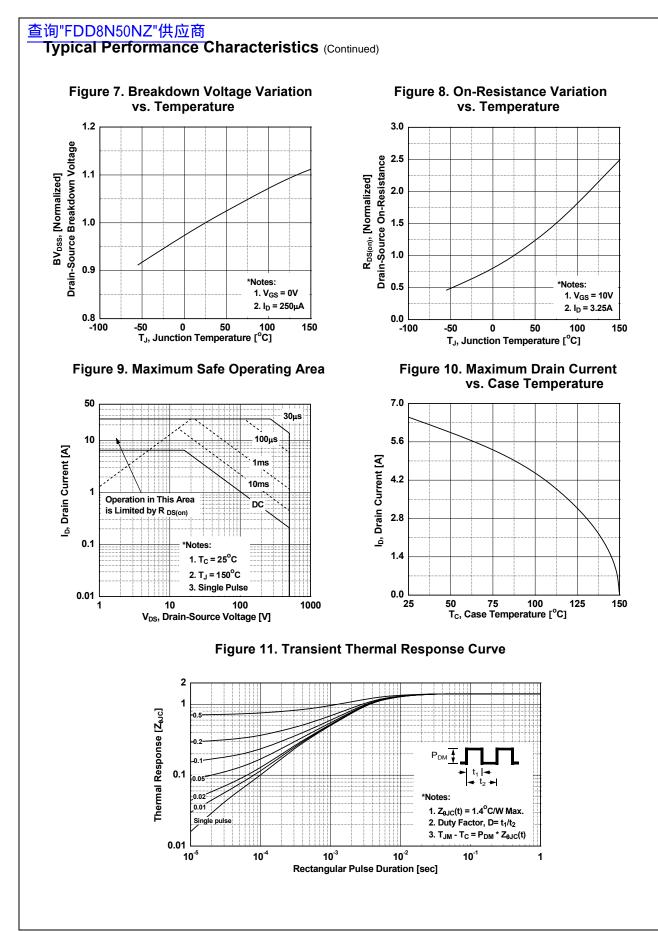
0 └ 0.1

30

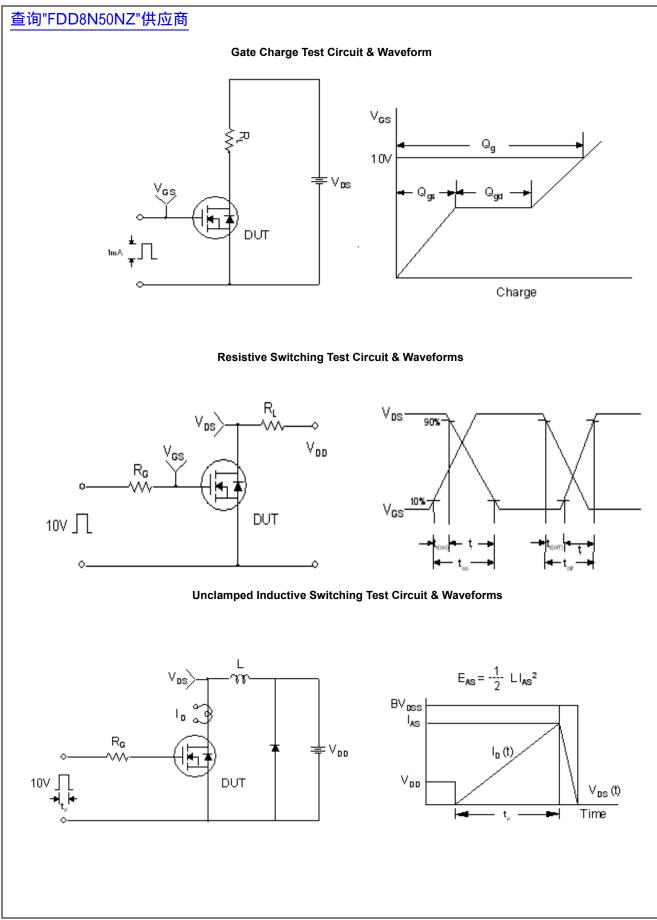
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V<sub>DS</sub>, Drain-Source Voltage [V]



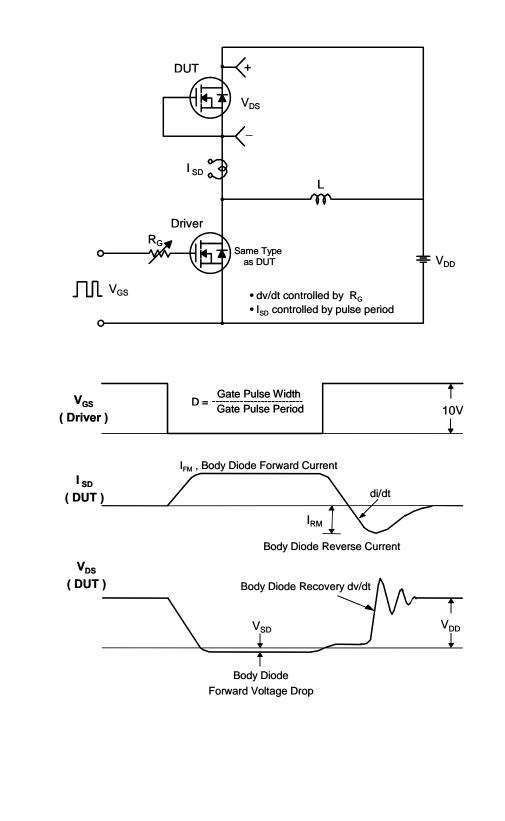
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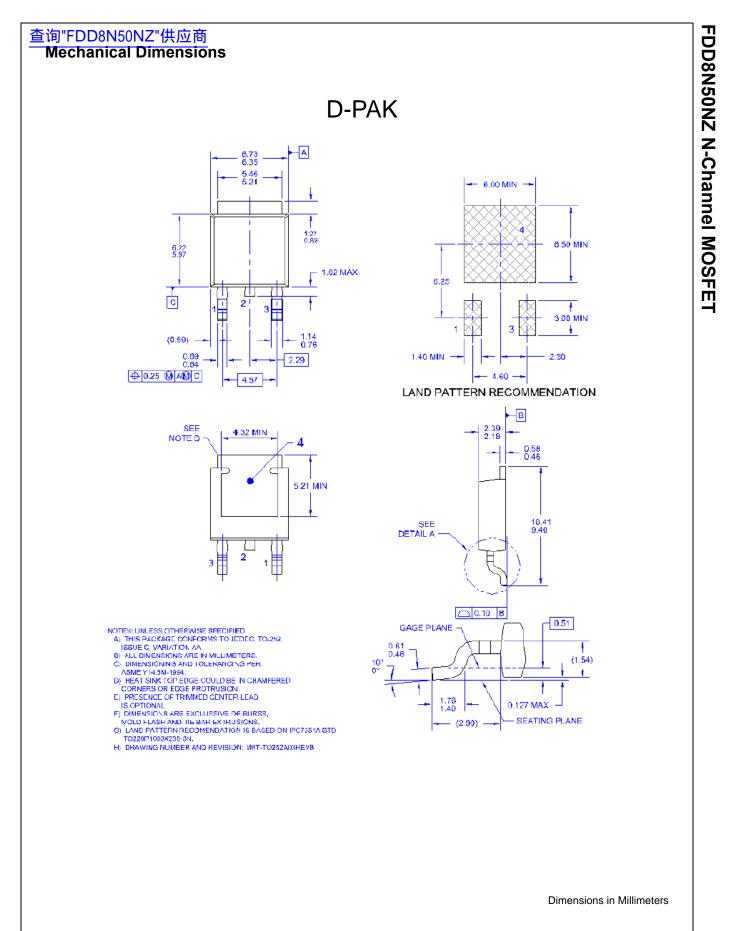




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#### Peak Diode Recovery dv/dt Test Circuit & Waveforms





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